

# LK112

### Low noise and low drop voltage regulator with shutdown function



### Features

- Output current up to 150 mA
- Low-dropout voltage (350 mV at I<sub>OUT</sub> = 150 mA)
- Very low quiescent current:
  - 0.1  $\mu$ A in OFF mode and max. 250  $\mu$ A in ON mode at I<sub>OUT</sub> = 0 mA
- Low output noise:
  - typ. 30 µV at I<sub>OUT</sub> = 60 mA and 10 Hz < f < 80 kHz
- Wide range of output voltages

#### **Datasheet - production data**

- Internal current and thermal limit
- Operative input voltage from:
  - V<sub>OUT</sub> + 0.5 to 14 V (for V<sub>OUT</sub> > 2 V) or from 2.5 V to 14 V (for V<sub>OUT</sub> < 2 V)

### Description

The LK112 is a low-dropout linear regulator with a built-in electronic switch. The internal switch can be controlled by TTL or CMOS logic levels. The device is on-state when the control pin is pulled to a logic high level. An external capacitor can be connected to the noise bypass pin to reduce the output noise level to 30 µVrms. An internal PNP pass transistor is used to achieve a low-dropout voltage. The LK112 has a very low quiescent current in on mode while in off mode  $I_{\alpha}$  is reduced below 100 nA max. The internal thermal shutdown circuitry limits the junction temperature below 150 °C. Load current is internally monitored and the device shuts down in the presence of a short-circuit or overcurrent condition on the output.

### Table 1. Device summary

Order codes	Output voltages
LK112M15TR	1.5V
LK112M18TR	1.8V
LK112M25TR	2.5V
LK112M33TR	3.3V
LK112M50TR	5.0V
LK112M55TR	5.5V
LK112M60TR	6.0V
LK112M80TR	8.0V

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# 1 Diagram

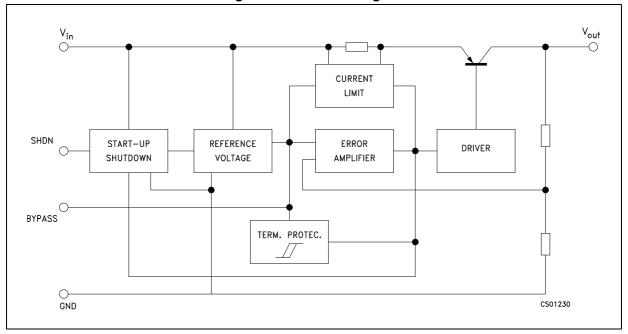
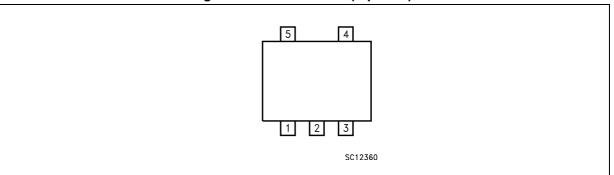


Figure 1. Schematic diagram



# 2 Pin configuration



### Figure 2. Pin connection (top view)

Table	2.	Pin	descri	otion
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Pin n°	Symbol	Note
1	SHDN	Shutdown input disables the regulator when it is connected to GND or to positive voltage less than 0.6 V $$
2	GND	Ground pin internally connected to the die attach flag to decrease the total thermal resistance and increase the package ability to dissipate power
3	Bypass	Bypass pin with 0.1 $\mu$ F to improve the noise performance
4	OUT	Output port
5	IN	Input port



# 3 Maximum ratings

Symbol	Parameter	Value	Unit
VI	DC input voltage	16	V
V <sub>SHDN</sub>	DC input voltage	16	V
Ι <sub>Ο</sub>	Output current	Internally limited	
T <sub>STG</sub>	Storage temperature range	-55 to 150	°C
T <sub>OP</sub>	Operating junction temperature range	-40 to 125	°C

### Table 4. Thermal data

Symbol	Parameter	SOT23-5L	Unit
R <sub>thJC</sub>	Thermal resistance junction-case	81	°C/W
R <sub>thJA</sub>	Thermal resistance junction-ambient	255	°C/W



### 4 Electrical characteristics

T<sub>J</sub> = 25 °C, V<sub>IN</sub> = V<sub>OUT</sub> + 1 V, I<sub>OUT</sub> = 0 mA, V<sub>SHDN</sub> = 1.8 V, C<sub>I</sub> = 1  $\mu$ F, C<sub>O</sub> = 2.2  $\mu$ F, C<sub>BYPASS</sub> = 0.1  $\mu$ F unless otherwise specified.

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
	On mode (except I <sub>SHDN</sub> )		175	250	μA	
Ι <sub>q</sub>	Quiescent current	Off mode, V <sub>I</sub> = 8V, V <sub>SHDN</sub> = 0V		0	0.1	μA
Vo	Output voltage	I <sub>O</sub> = 30mA	-2		+2	%
A) /	Line regulation	$V_{I} = V_{O}$ +1V to $V_{O}$ +6V, $V_{O} \le 5.6V$		0.7	20	mV
$\Delta V_O$	Line regulation	$V_{I} = V_{O}$ +1V to $V_{O}$ +6V, $V_{O}$ > 5.6V		0.8	40	mV
A) /	Lood regulation	I <sub>O</sub> = 1 to 60mA		15	30	mV
$\Delta V_{O}$ Load regulation	Load regulation	I <sub>O</sub> = 1 to 150mA		25	90	mV
V <sub>d</sub> Dropout volt	Dranaut voltage	$I_{O} = 60 \text{mA}^{(1)}$		0.17	0.24	V
	Dropout voltage	I <sub>O</sub> = 150mA <sup>(1)</sup>		0.29	0.35	V
Ι <sub>Ο</sub>	Output current limit		150			mA
SVR	Supply voltage rejection	$V_{I} = V_{O}+1.5V, C_{BYP} = 0.1\mu F$ $C_{O} = 10\mu F, f = 400Hz, I_{O} = 30mA$		55		dB
eN	Output noise voltage	$      B= 10Hz \text{ to } 80\text{kHz}, \ C_{\text{BYP}} = 0.1 \mu\text{F} \\ C_{\text{O}} = 10 \mu\text{F}, \ V_{\text{I}} = V_{\text{O}} + 1.5 \text{V}, \ I_{\text{O}} = 60\text{mA} $		30		µVrms
I <sub>SHDN</sub>	Shutdown input current	V <sub>SHDN</sub> = 1.8V, output on		12	35	μA
	Shutdown input logic	Output on	1.8			V
V <sub>SHDN</sub>	Shutdown input logic	Output off			0.6	V
$\Delta V_{O}/T_{J}$	Output voltage temperature coefficient	I <sub>O</sub> = 10mA		0.09		mV/°C

Table 5. LK112 electrical	characteristics
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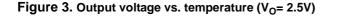
1. For versions with output voltage more than 2.1 V only.

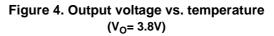
Note: For version with output voltage less than 2 V,  $V_{IN} = 2.4$  V.

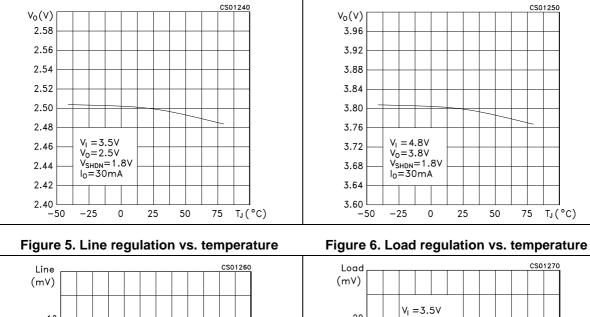
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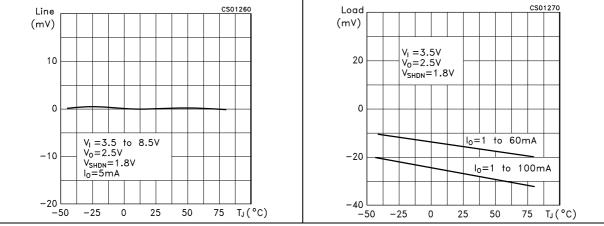
### 5 Typical characteristics

Unless otherwise specified, T\_J = 25 °C, C\_I = 1  $\mu$ F, C\_O = 2.2  $\mu$ F, C<sub>BYP</sub> = 100 nF











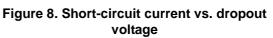
 $V_{d}(V)$ 

0.3

0.2

0.1

0 └ -50



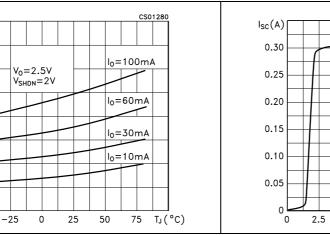


Figure 9. Output voltage vs. input voltage

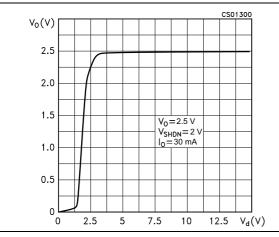


Figure 11. Shutdown current vs. shutdown voltage

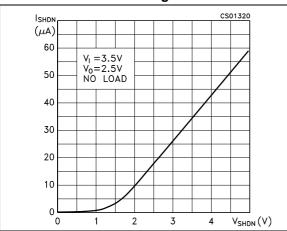


Figure 10. Shutdown voltage vs. temperature

7.5

10

12.5

 $V_{d}(V)$ 

5

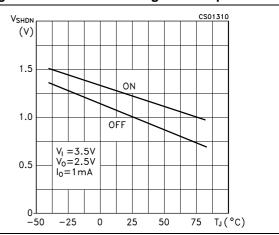
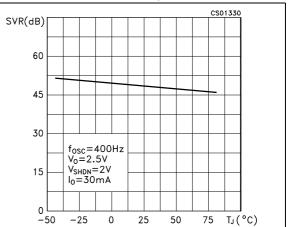


Figure 12. Supply voltage rejection vs. temperature (V<sub>0</sub>= 2.5V)

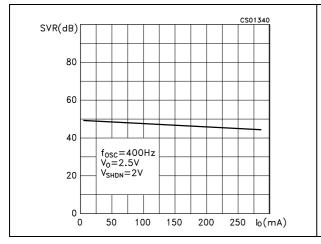




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V<sub>0</sub>=2.5V

Figure 13. Supply voltage rejection vs. output current



# Figure 15. Supply voltage rejection vs. temperature (V<sub>O</sub>= 3.8V)

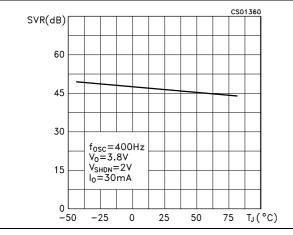


Figure 17. Quiescent current vs. input voltage

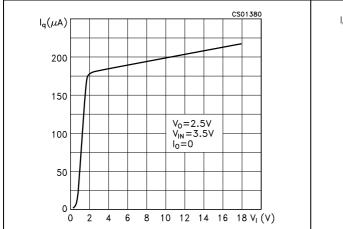
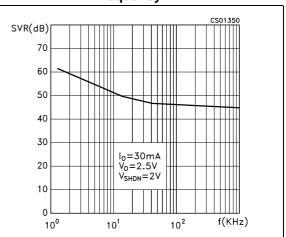


Figure 14. Supply voltage rejection vs. frequency



### Figure 16. Quiescent current vs. temperature

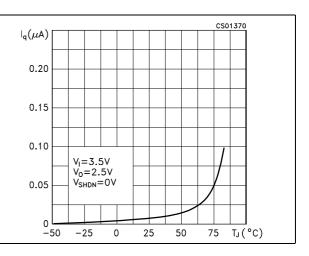
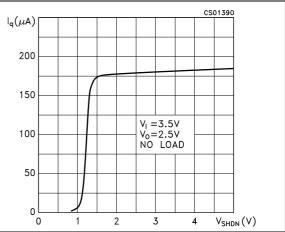
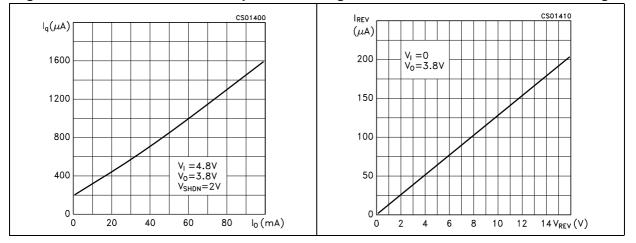


Figure 18. Quiescent current vs. shutdown voltage

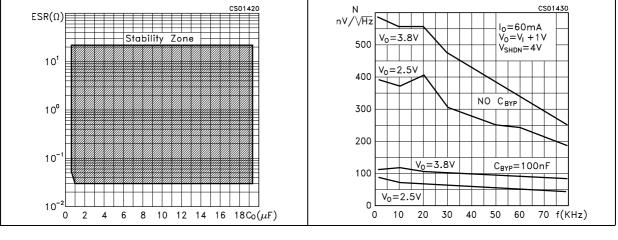






#### Figure 19. Quiescent current vs. output current Figure 20. Reverse current vs. reverse voltage

Figure 21. Stability





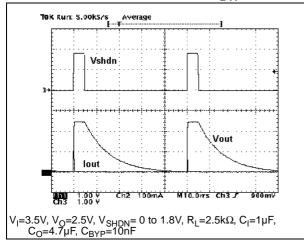
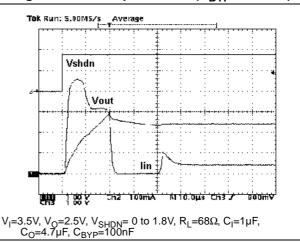


Figure 24. Start-up transient (C<sub>BYP</sub> = 100 nF)

Figure 22. Noise spectrum





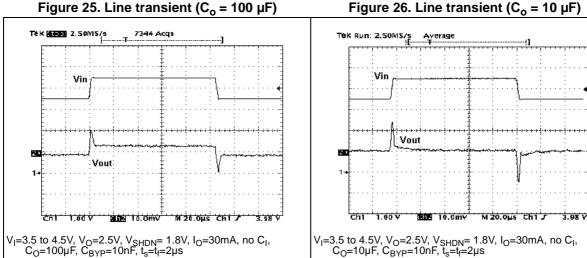


Figure 27. Line transient ( $C_o = 1 \mu F$ )

Figure 28. Load transient ( $C_o = 2.2 \mu F$ ,  $C_{BYP} = 10 \text{ nF}$ 

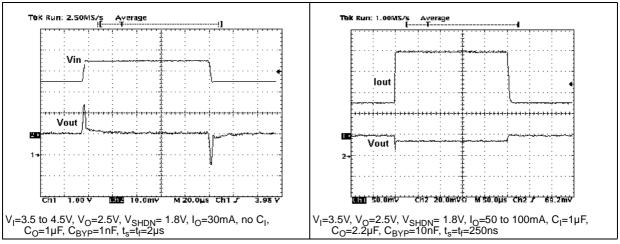
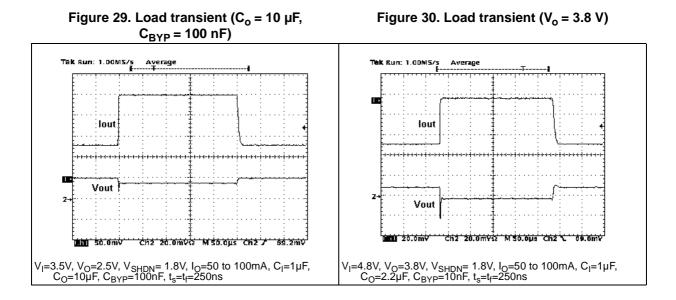




Figure 25. Line transient ( $C_o = 100 \ \mu F$ )



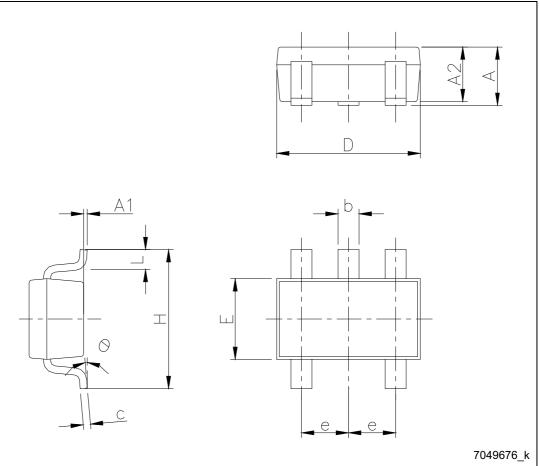




## 6 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK<sup>®</sup> is an ST trademark.

Figure 31.SOT23-5L mechanical drawings

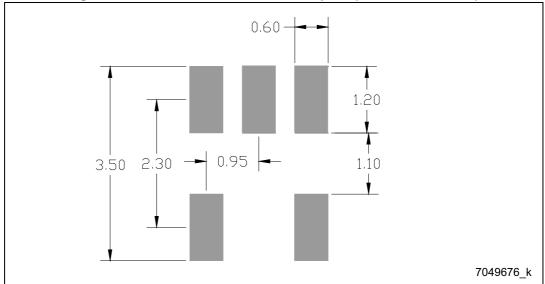




Dim.	mm				
	Min.	Тур.	Max.		
А	0.90		1.45		
A1	0		0.15		
A2	0.90		1.30		
b	0.30		0.50		
С	2.09		0.20		
D		2.95			
E		1.60			
е		0.95			
Н		2.80			
L	0.30		0.60		
θ	0		8		

Table 6. SOT23-5L mechanical data







# 7 Packaging mechanical data

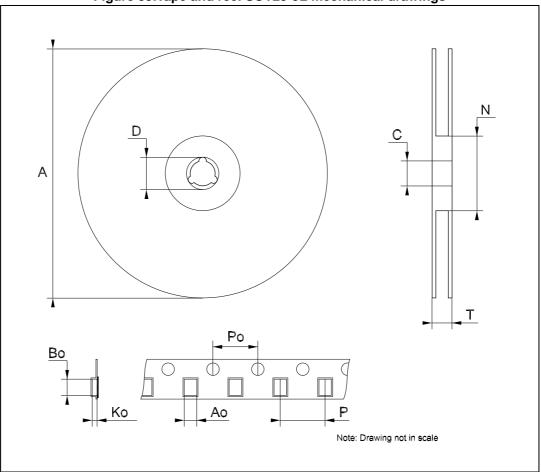


Figure 33.Tape and reel SOT23-5L mechanical drawings



Dim.		mm		
	Min.	Тур.	Max.	
А			180	
С	12.8	13.0	13.2	
D	20.2			
Ν	60			
Т			14.4	
Ao	3.13	3.23	3.33	
Во	3.07	3.17	3.27	
Ko	1.27	1.37	1.47	
Po	3.9	4.0	4.1	
Р	3.9	4.0	4.1	

Eiguro 34	Tano and roo	SOT22-51	mechanical data
Figure 34	. Tape and ree	SUI23-3L	mechanical uala

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# 8 Revision history

Date	Revision	Changes
31-Jan-2005	8	Change maturity code.
13-Jun-2006	9	Order codes updated and new template.
17-Oct-2006	10	The T <sub>OP</sub> value on table 2 has been updated.
18-Jul-2007	11	Add <i>Table 1</i> in cover page.
21-Sep-2007	12	Features updated.
11-Dec-2007	13	Modified: Table 1.
12-Feb-2008	14	Modified: Table 1.
10-Jul-2008	15	Modified: Table 1 and Table 1 on page 1.
28-Feb-2011	16	Modified: Table 1.
24-Apr-2014	17	Changed the part number LK112xx to LK112. Updated the Title in cover page and Table 1: Device summary. Updated the features and description in cover page, Table 2: Pin description, Figure 3: Output voltage vs. temperature (VO= 2.5V), Figure 4: Output voltage vs. temperature (VO= 3.8V), Section 5: Typical characteristics, Section 6: Package mechanical data. Added Section 7: Packaging mechanical data. Minor text changes.

#### Table 7. Document revision history



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